www.vishay.com

Vishay Beyschlag

## **Precision Metal Film Leaded Resistors**



## **FEATURES**

- IECQ-CECC approved according to EN 140101-806
- Superior overall stability: class 0.05
- Wide precision ohmic range: 10  $\Omega$  to 1.5 M $\Omega$
- Radial version available for MBB/SMA 0207
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>



#### **APPLICATIONS**

- Test and measuring equipment
- · Industrial electronics
- Medical electronics

#### **DESCRIPTION**

MBA/SMA 0204, MBB/SMA 0207, and MBE/SMA 0414 precision leaded thin film resistors combine the proven reliability of the professional products with an advanced level of precision and stability. Therefore they are perfectly suited for applications in the fields of test and measuring equipment along with industrial and medical electronics.

TECHNICAL SPECIFICATIONS		TECHNICAL SPECIFICATIONS						
DESCRIPTION	MBA/SMA 0204	MBB/SMA 0207	MBE/SMA 0414					
DIN size	0204	0207	0414					
CECC size	A	В	D					
Resistance range	22 $\Omega$ to 332 k $\Omega$	10 Ω to 1 MΩ	22 $\Omega$ to 1.5 M $\Omega$					
Resistance tolerance ± 0.25 %; ± 0.1 %								
Temperature coefficient	± 25 ppm/K; ± 15 ppm/K							
Rated dissipation, P <sub>70</sub>	0.25 W	0.40 W	0.65 W					
Operating voltage, U <sub>max.</sub> AC/DC	200 V	200 V 350 V						
Operating temperature range (1)		-55 °C to +125 °C						
Peak permissible film temperature (1)	125 °C	125 °C	125 °C					
Insulation voltage:								
1 min; <i>U</i> <sub>ins</sub>	300 V 500 V		800 V					
Continuous	75 V	75 V	75 V					
Failure rate: FIT <sub>observed</sub> ≤ 0.1 x 10 <sup>-9</sup> /h								

#### **Notes**

- MB\_ series has been merged with the related SMA series to form one series "MB\_/SMA\_\_".
- (1) Please refer to APPLICATION INFORMATION below.

Vishay Beyschlag

#### **APPLICATION INFORMATION**

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

<b>MAXIMUM RESISTANCE CHA</b>	NGE AT RATED DISS	SIPATION	
Operation mode		Precision	Standard
Climatic category		-10 °C / +85 °C / 56 days	-55 °C / +125 °C / 56 days
	MBA/SMA 0204	0.07 W	0.25 W
Rated dissipation, P <sub>70</sub>	MBB/SMA 0207	0.11 W	0.40 W
	MBE/SMA 0414	0.17 W	0.65 W
Applied maximum film temperature, $\vartheta_{\text{F max}}$	ζ.	85 °C	125 °C
	MBA/SMA 0204	100 Ω to 100 kΩ	100 Ω to 100 kΩ
	1000 h	≤ 0.05 %	≤ 0.25 %
	8000 h	≤ 0.1 %	≤ 0.5 %
	225 000 h	≤ 0.3 %	≤ 1.5 %
	MBB/SMA 0207	100 Ω to 270 kΩ	100 Ω to 270 kΩ
Max. resistance change at rated	1000 h	≤ 0.03 %	≤ 0.15 %
dissipation  ∆R/R max. , after:	8000 h	≤ 0.1 %	≤ 0.5 %
	225 000 h	≤ 0.3 %	≤ 1.5 %
	MBE/SMA 0414	100 Ω to 470 kΩ	100 Ω to 470 kΩ
	1000 h	≤ 0.05 %	≤ 0.25 %
	8000 h	≤ 0.1 %	≤ 0.5 %
	225 000 h	≤ 0.3 %	≤ 1.5 %

TEMPERATURE C	DEFFICIENT AND RI	ESISTANCE RANGE		
TYPE	TCR	TOLERANCE	RESISTANCE (1)	E-SERIES
	± 25 ppm/K	± 0.25 %	22 $\Omega$ to 332 k $\Omega$	E96; E192
MBA/SMA 0204	± 25 ppi1/K	± 0.1 %	43 $\Omega$ to 332 k $\Omega$	E96; E192
IVIDA/SIVIA UZU4	+ 15 nnm/k	± 0.25 %	22 $\Omega$ to 221 k $\Omega$	E96; E192
	± 15 ppm/K	± 0.1 %	43 $\Omega$ to 221 k $\Omega$	E96; E192
	± 25 ppm/K	± 0.25 %	10 $\Omega$ to 1 M $\Omega$	E96; E192
MBB/SMA 0207		± 0.1 %	10 Ω to 1 MΩ	E96; E192
IVIDD/SIVIA UZU/	± 15 ppm/K	± 0.25 %	10 Ω to 1 MΩ	E96; E192
		± 0.1 %	10 $\Omega$ to 1 M $\Omega$	E96; E192
MBE/SMA 0414	. 25 nnm/V	± 0.25 %	22 Ω to 1.5 MΩ	E96; E192
	± 25 ppm/K	± 0.1 %	43 $\Omega$ to 1 M $\Omega$	E96; E192
IVIDE/SIVIA 0414	. 15 nnm/V	± 0.25 %	22 $\Omega$ to 1 M $\Omega$	E96; E192
	± 15 ppm/K	± 0.1 %	43 Ω to 1 MΩ	E96; E192

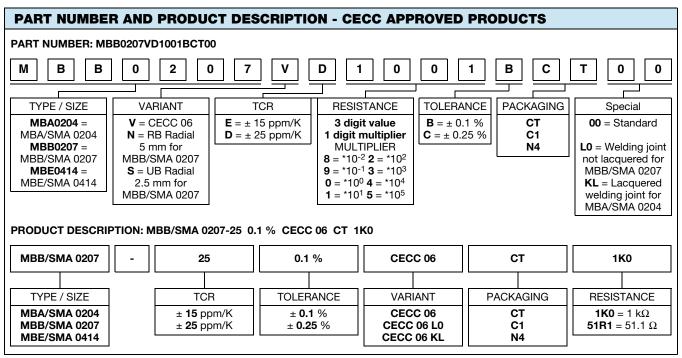
#### **Notes**

• Radial version (RB, UB) cannot be qualified according to CECC so these can only be ordered with variant N or S.

<sup>(1)</sup> Approval is according to EN 140101-806, version A.

www.vishay.com

Vishay Beyschlag



#### Note

• The products can be ordered using either the PRODUCT DESCRIPTION or the PART NUMBER.

PACKAGING						
TYPE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	DIMENSIONS
MBA/SMA 0204	C1	1000	Taped acc. to IEC 60286-1	53 mm	5 mm	184 mm x 75 mm x 42 mm
IVIDAV SIVIA UZU4	CT	5000	fan-folded in a box	55 11111	3 111111	330 mm x 75 mm x 55 mm
MBB/SMA 0207	C1	1000	Taped acc. to IEC 60286-1	53 mm	5 mm	184 mm x 74 mm x 42 mm
IVIDB/SIVIA 0207	CT	5000	fan-folded in a box	33 111111	3 111111	324 mm x 77 mm x 82 mm
MBB/SMA 0207	N4	4000	Taped acc. to IEC 60286-2 fan-folded in a box	-		330 mm x 262 mm x 45 mm
UB = 2.5 mm pitch	R4	4000	Taped acc. to IEC 60286-2 on a reel	-	12.7 mm	330 mm x 253 mm x 48 mm
MBB/SMA 0207	N4	4000	Taped acc. to IEC 60286-2 fan-folded in a box	-	12.7 111111	330 mm x 262 mm x 45 mm
UB = 5.0 mm pitch	R4	4000	Taped acc. to IEC 60286-2 on a reel	-		330 mm x 253 mm x 48 mm
MBE/SMA 0414	C1	1000	Taped acc. to IEC 60286-1 fan-folded in a box	63 mm	5 mm	374 mm x 84 mm x 47 mm

#### Note

• For details related to packaging specs, refer datasheet link www.vishay.com/doc?28721.

Vishay Beyschlag

## **DESCRIPTION**

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body and conditioned to achieve the desired temperature coefficient. Plated steel termination caps are firmly pressed on the metallized rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. Connecting wires of electrolytic copper plated with 100 % pure tin are welded to the termination caps. The resistor elements are covered by a light blue protective coating designed for electrical, mechanical and climatic protection. Four or five color code rings designate the resistance value and tolerance in accordance with IEC 60062.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual resistors. Only accepted products are stuck directly on the adhesive tapes in accordance with IEC 60286-1 or for the radial versions in accordance to IEC 60286-2.

#### **MATERIALS**

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (1)
- The Global Automotive Declarable Substance List (GADSL) (2)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (3) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

#### **ASSEMBLY**

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines. Excellent solderability is proven, even after extended storage. They are suitable for automatic soldering using wave or dipping.

The resistors are completely lead (Pb)-free, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The immunity of the plating against tin whisker growth, in compliance with IEC 60068-2-82, has been proven under extensive testing.

The encapsulant is resistant to cleaning solvent specified in IEC 60115-1 <sup>(3)</sup>. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

All products comply with **GADSL** <sup>(1)</sup> and the **IEC 62474** <sup>(2)</sup> list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle Life Directive (ELV) and Annex II (ELVII)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electrical Equipment Directive (WEEE)

#### **APPROVALS**

The resistors (CECC version) are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification EN 140101-806 which refers to EN 60115-1 and EN 140100 and the variety of environmental test procedures of the IEC 60068 series. Conformity is attested by the use of the CECC logo (a) as the Mark of Conformity on the package label for the CECC version.

Vishay Beyschlag has achieved "Approval of Manufacturer" in accordance with IEC QC 001002-3, clause 2. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IEC QC 001002-3, clause 6 is granted for the Vishay Beyschlag manufacturing process.

#### **RELATED PRODUCTS**

For a corelated range of professional TCR and tolerance specifications see the datasheet:

 "Professional Thin Film Leaded Resistors", <u>www.vishav.com/doc?28766</u>

For products approved to EN 140101-806, version E, with established reliability and failure rate level E7 (Quality factor  $\pi Q = 0.1$ ), see the datasheet:

 "Established Reliability Thin Film Leaded Resistors", www.vishay.com/doc?28768

## Notes

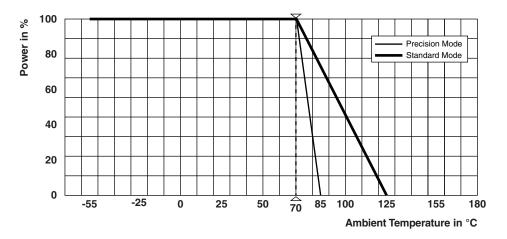
(1) Global Automotive Declarable Substance List, see www.gadsl.org

(2) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see <a href="https://www.digitaleurope.org/SearchResults.aspx?Search=eicta">www.digitaleurope.org/SearchResults.aspx?Search=eicta</a>.

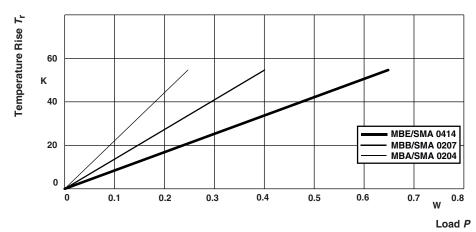
All products comply with the IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry.

(3) Other cleaning solvents with aggressive chemicals should be evaluated in actual cleaning process for their suitability.

## **FUNCTIONAL PERFORMANCE**

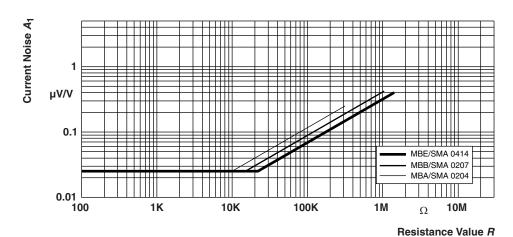


## **Derating**



Rise of the surface temperature.

## **Temperature Rise**



Current Noise A<sub>1</sub> in accordance with IEC 60195



www.vishay.com

Vishay Beyschlag

#### **TEST PROCEDURES AND REQUIREMENTS**

Essentially all tests are carried out in accordance with the following specifications:

- EN 60115-1, Generic specification (includes tests)
- EN 140100, Sectional specification (includes schedule for qualification approval)
- EN 140101-806 (successor of CECC 40101-806), Detail specification (includes schedule for conformance inspection)

Most of the components are approved in accordance with the European CECC-system, where applicable. The Test Procedures and Requirements table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068-2-xx test method and under standard atmospheric conditions in

accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper category temperature; damp heat, steady state, test duration: 56 days) is valid.

Unless otherwise specified the following values apply:

- Temperature: 15 °C to 35 °C
- Relative humidity: 45 % to 75 %
- Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).
   For testing the components are mounted on a test board in accordance with IEC 60115-1, 4.31 unless otherwise specified.

In the Test Procedures and Requirements table, only the tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given.

TEST	PROCE	DURES AN	ID REQUIREMENTS			
			PROCEDURE	REQUIRE	MENTS PERMISSIBLE (ΔR max.)	CHANGE
IEC 60115-1	IEC 60068-2	TEST	Stability for product types:	STABILITY CLASS 0.05	STABILITY CLASS 0.1	STABILITY CLASS 0.25
CLAUSE	TEST METHOD	1201	MBA/SMA 0204	100 Ω to 100 kΩ	43 Ω to 221 kΩ	22 $\Omega$ to 332 k $\Omega$
			MBB/SMA 0207	100 $\Omega$ to 270 k $\Omega$	43 $\Omega$ to 510 k $\Omega$	22 $\Omega$ to 1 M $\Omega$
			MBE/SMA 0414	100 $\Omega$ to 470 $k\Omega$	43 $\Omega$ to 1 M $\Omega$	22 $\Omega$ to 1.5 M $\Omega$
4.5	-	Resistance	-		± 0.25 %; ± 0.1 %	
4.7	-	Voltage proof	$U_{\text{RMS}} = U_{\text{ins}}$ ; 60 s	N	lo flashover or breakdov	vn
4.8	-	Temperature coefficient	At 20/LCT/20 °C and 20/UCT/20 °C		± 25 ppm/K; ± 15 ppm/k	<
4.13	-	Short time overload	Room temperature; $U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max}$ ; 5 s	$\pm$ (0.01 % $R$ + 0.01 $\Omega$ ) no visible damage	± (0.02 % <i>R</i> + 0.01 Ω) no visible damage	$\pm$ (0.05 % $R$ + 0.01 $\Omega$ ) no visible damage
4.16	21 (Ua <sub>1</sub> ) 21 (Ub) 21 (Uc)	Robustness of terminations	Tensile, bending and torsion	± (0.01 % R + 0.01 Ω)	± (0.02 % R + 0.01 Ω)	± (0.05 % R + 0.01 Ω)
4.17	20 (Ta)	Solderability	+235 °C; 2 s solder bath method; SnPb40	Cond tinning	ı (≥ 95 % covered, no vis	sible demage)
4.17	20 (Ta)	Solderability	+245 °C; 3 s solder bath method; SnAg3Cu0.5	Good tillling	y (≥ 93 % covered, no vis	ыые сатаде)
4.18.2	20 (Tb)	Resistance to soldering heat	Unmounted components; $(270 \pm 3)$ °C; $(10 \pm 1)$ s	$\pm$ (0.01 % $R$ + 0.01 $\Omega$ ) no visible damage	± (0.02 % <i>R</i> + 0.01 Ω) no visible damage	$\pm$ (0.05 % $R$ + 0.01 $\Omega$ ) no visible damage
			30 min at LCT = -55 °C 30 min at UCT = 125 °C			
4.19	14 (Na)	Rapid change of	5 cycles	$\pm$ (0.01 % $R$ + 0.01 $\Omega$ ) no visible damage	$\pm$ (0.02 % $R$ + 0.01 $\Omega$ ) no visible damage	$\pm$ (0.05 % $R$ + 0.01 $\Omega$ ) no visible damage
	temperature		MBA/SMA 0204: 500 cycles MBB/SMA 0207: 200 cycles MBE/SMA 0414: 100 cycles	$\pm$ (0.25 % $R$ + 0.05 $\Omega$ ) no visible damage	± (0.25 % <i>R</i> + 0.05 Ω) no visible damage	$\pm$ (0.25 % $R$ + 0.05 $\Omega$ ) no visible damage
4.22	6	Vibration	10 sweep cycles per direction; 10 Hz to 2000 Hz 1.5 mm or 200 m/s <sup>2</sup>	± (0.01 % R + 0.01 Ω)	± (0.02 % R + 0.01 Ω)	± (0.05 % R + 0.01 Ω)



www.vishay.com

Vishay Beyschlag

			PROCEDURE	REQUIRE	MENTS PERMISSIBLE	CHANGE	
IEC	IEC		Stability for product types:	STABILITY	(ΔR max.) STABILITY	STABILITY	
60115-1	60068-2 TEST TEST		, , , , , , , , , , , , , , , , , , ,	CLASS 0.05	CLASS 0.1	CLASS 0.25	
CLAUSE	METHOD		MBA/SMA 0204	100 Ω to 100 kΩ	43 Ω to 221 kΩ	22 Ω to 332 kΩ	
			MBB/SMA 0207	100 Ω to 270 kΩ	43 Ω to 510 kΩ	22 Ω to 1 MΩ	
4.23		Climatic	MBE/SMA 0414	100 Ω to 470 kΩ	43 Ω to 1 MΩ	22 Ω to 1.5 MΩ	
4.23		sequence:					
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h				
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; 90 % to 100 % RH; 1 cycle	± (0.05 % R + 0.01 Ω)	± (0.1 % R + 0.01 Ω)	± (0.25 % R + 0.05 Ω)	
4.23.4	1 (Aa)	Cold	-55 °C; 2 h	no visible damage	no visible damage	no visible damage	
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; 15 °C to 35 °C				
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 5 days; 95 % to 100 % RH; 5 cycles				
4.23.7		DC load	Apply rated power for 1 min				
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.05 % R + 0.01 Ω)	± (0.1 % R + 0.01 Ω)	± (0.25 % R + 0.05 Ω)	
	-	Endurance at 70 °C: Precision	$U = \sqrt{P_{70} \times R} \text{ or }$ $U = U_{\text{max}};$ 1.5 h on; 0.5 h off				
		operation	70 °C; 1000 h	$\pm (0.05 \% R + 0.01 \Omega)^{(1)}$	$\pm~(0.1~\%~R+0.01~\Omega)$	$\pm (0.25 \% R + 0.05 \Omega)^{(2)}$	
4.25.1		mode	70 °C; 8000 h	± (0.1 % R + 0.01 Ω)	$\pm (0.2 \% R + 0.01 \Omega)$	± (0.5 % R + 0.05 Ω)	
4.20.1	_	Endurance at 70 °C: Standard	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$ ; 1.5 h on; 0.5 h off				
		operation	70 °C; 1000 h	$\pm~(0.25~\%~R+0.05~\Omega)~^{(2)}$	-	-	
		mode	70 °C; 8000 h	$\pm (0.5 \% R + 0.05 \Omega)$	-	-	
4.25.3	1	Endurance at upper category temperature	85 °C; 1000 h 125 °C; 1000 h	± (0.05 % R + 0.01 Ω)	± (0.1 % R + 0.01 Ω)	- ± (0.25 % R + 0.05 Ω)	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol +23 °C; toothbrush method		Marking legible; No visible damage		
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 pos. + 3 neg. MBA/SMA 0204: 2 kV MBB/SMA 0207: 4 kV MBE/SMA 0414: 6 kV	± (0.5 % R + 0.05 Ω)			

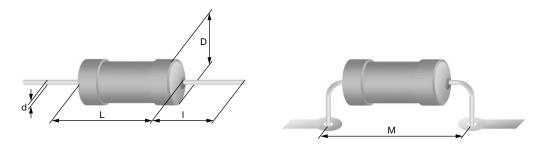
#### Notes

 $<sup>^{(1)}~\</sup>pm$  (0.03 % R + 0.01  $\Omega)$  for MBB/SMA 0207

 $<sup>^{(2)}~\</sup>pm$  (0.15 % R + 0.05  $\Omega)$  for MBB/SMA 0207

Vishay Beyschlag

#### **DIMENSIONS**

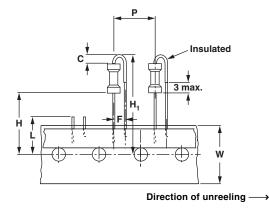


<b>DIMENSIONS</b> - Leaded resistor types, mass and relevant physical dimensions							
TYPE D <sub>max.</sub> L <sub>max.</sub> d <sub>nom.</sub> I <sub>min.</sub> M <sub>min.</sub> MAS (mm) (mm) (mm) (mm)							
MBA/SMA 0204	1.6	3.6	0.5	29.0	5.0	125	
MBB/SMA 0207 (1)	2.5	6.3	0.6	28.0	10.0 <sup>(1)</sup>	220	
MBE/SMA 0414	4.0	11.9	0.8	31.0	15.0	700	

#### Note

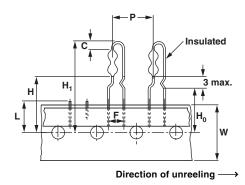
#### MBB/SMA 0207 WITH RADIAL TAPING

## LEAD SPACING (UB = 2.5 mm), SIZE 0207



DIMENSIONS in millimeters					
Pitch of components	Р	12.7 ± 1.0			
Lead spacing	F	2.5 + 0.6 / - 0.1			
Width of carrier tape	W	18.0 + 1.0 / - 0.5			
Body to hole center	Н	18.0 ± 2.0			
Height for cutting (max.)	L	11			
Height for bending	С	2.5 + 0 / - 0.5			
Height for insertion (max.)	H1	32			

## LEAD SPACING (RB = 5.0 mm), SIZE 0207



<b>DIMENSIONS</b> in millimeters					
Pitch of components	Р	12.7 ± 1.0			
Lead spacing	F	5.0 + 0.6 / - 0.1			
Width of carrier tape	W	18.0 + 1.0 / - 0.5			
Body to hole center	Н	18.0 ± 2.0			
Lead crimp to hole center	H <sub>0</sub>	16.0 ± 0.5			
Height for cutting (max.)	L	11			
Height for bending	С	2.5 + 0 / - 0.5			
Height for insertion (max.)	H <sub>1</sub>	32			

<sup>(1)</sup> For  $7.5 \le M < 10.0$  mm, use version MBB/SMA 0207... L0 (welding joint not lacquered)

Vishay Beyschlag

## **HISTORICAL 12NC INFORMATION**

- The resistors had a 12-digit numeric code starting with 2312
- The subsequent 4 digits indicated the resistor type, specification and packaging; see the 12NC table
- The remaining 4 digits indicated the resistance value:
  - The first 3 digits indicated the resistance value
  - The last digit indicated the resistance decade in accordance with resistance decade table shown below

#### **Resistance Decade**

RESISTANCE DECADE	LAST DIGIT
10 Ω to 99.9 Ω	9
100 $\Omega$ to 999 $\Omega$	1
1 k $\Omega$ to 9.99 k $\Omega$	2
10 k $\Omega$ to 99.9 k $\Omega$	3
100 k $\Omega$ to 999 k $\Omega$	4
1 M $\Omega$ to 9.99 M $\Omega$	5

## **Historical 12NC Example**

The 12NC code of a MBA 0204 resistor, value 47 k $\Omega$  and TCR 25 with  $\pm$  0.1 % tolerance, supplied on bandolier in a box of 5000 units was: 2312 906 74703.

			ype and packaging 2312 (BANDOLIER)					
DESCRIPTION	N		AMMO	PACK		REEL		
TYPE	TCR	TOL.	C1 1000 UNITS	CT 5000 UNITS	R1 1000 UNITS	R2 2500 UNITS	RP 5000 UNITS	
	. 05 nnm/V	± 0.25 %	901 6	906 6	701 6	-	806 6	
MDA 0004	± 25 ppm/K	± 0.1 %	901 7	906 7	701 7	-	806 7	
MBA 0204	. 15 nnm/V	± 0.25 %	902 6	907 6	702 6	-	807 6	
	± 15 ppm/K	± 0.1 %	902 7	907 7	702 7	-	807 7	
	. 05//	± 0.25 %	911 6	916 6	711 6	-	816 6	
MDD 0007	± 25 ppm/K	± 0.1 %	911 7	916 7	711 7	-	816 7	
MBB 0207	45	± 0.25 %	912 6	917 6	712 6	-	817 6	
	± 15 ppm/K	± 0.1 %	912 7	917 7	712 7	-	817 7	
	. 05//	± 0.25 %	921 6	-	-	826 6	-	
MBE 0414	± 25 ppm/K	± 0.1 %	921 7	-	-	826 7	-	
	. 15 //	± 0.25 %	922 6	-	-	827 6	-	
	± 15 ppm/K	± 0.1 %	922 7	-	=	827 7	-	



# **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000